

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

Send any inquiries to <http://www.renesas.com/inquiry>.

Notice

1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
2. Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
7. Renesas Electronics products are classified according to the following three quality grades: “Standard”, “High Quality”, and “Specific”. The recommended applications for each Renesas Electronics product depends on the product’s quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as “Specific” without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics product for any application for which it is not intended without the prior written consent of Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as “Specific” or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is “Standard” unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - “Standard”: Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - “High Quality”: Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anti-crime systems; safety equipment; and medical equipment not specifically designed for life support.
 - “Specific”: Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.

(Note 1) “Renesas Electronics” as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries.

(Note 2) “Renesas Electronics product(s)” means any product developed or manufactured by or for Renesas Electronics.

H8SX Series

Four-Phase Pulse Output Using a PPG

Introduction

As well as having an architecture that is upward-compatible with each CPU of the H8/300, H8/300H, and H8S series, so as to inherit a full complement of peripheral functions, the H8SX microcomputer series has a maximum operating frequency of 50 MHz and uses a 32-bit H8SX core CPU as well as an on-chip multiplier/divider to improve performance.

This H8SX series Application Note provides information you may need during software and hardware design. This is a basic edition that provides operation examples that each use a single H8SX series on-chip peripheral function.

Although the operation of each program, circuit, and other aspects covered by this application note has been checked, make sure that you conduct your own operation checks before actually using the H8SX series.

Contents

1. Overview	2
2. Configuration.....	2
3. Sample Program	4

1. Overview

One channel of the 16-bit pulse unit (TPU) and one output group of the programmable pulse generator (PPG) of the H8SX series are used to output four-phase pulses. You can use all four timer channels, TPU0 to TPU3, and PPG output groups 0 to 3 to output four-channel 4-bit asynchronous pulses.

The TPU compare matches are used as the PPG start factors. You can also set a non-overlap period between multiple pulse outputs.

2. Configuration

The example shown below uses channel 3 (TPU3) of the 16-bit timer pulse unit and output group 3 of the programmable pulse generator (PPG). This sample uses the compare matches of TPU3 timer general registers A (TGRA_3) and B (TGRB_3) as pulse output triggers. When compare match B occurs, the PPG changes the pulse output level from high to low. When compare match A occurs, it changes the pulse output level from low to high. The time between the occurrences of compare matches B and A becomes the non-overlap period. The update processing of the PPG next data register (NDR) is performed not between the occurrences of compare matches from B to A, but between those of compare matches from A to B (this processing is implemented as part of the compare match A interrupt processing). You can set any pulse output timing within the range of values that can be set in the timer general registers. When the peripheral module clock ($P\phi$) is 25 MHz and the count clock is $P\phi/1$, you can set up to 2.62 msec in each timer general register. Figure 1 is a block diagram.

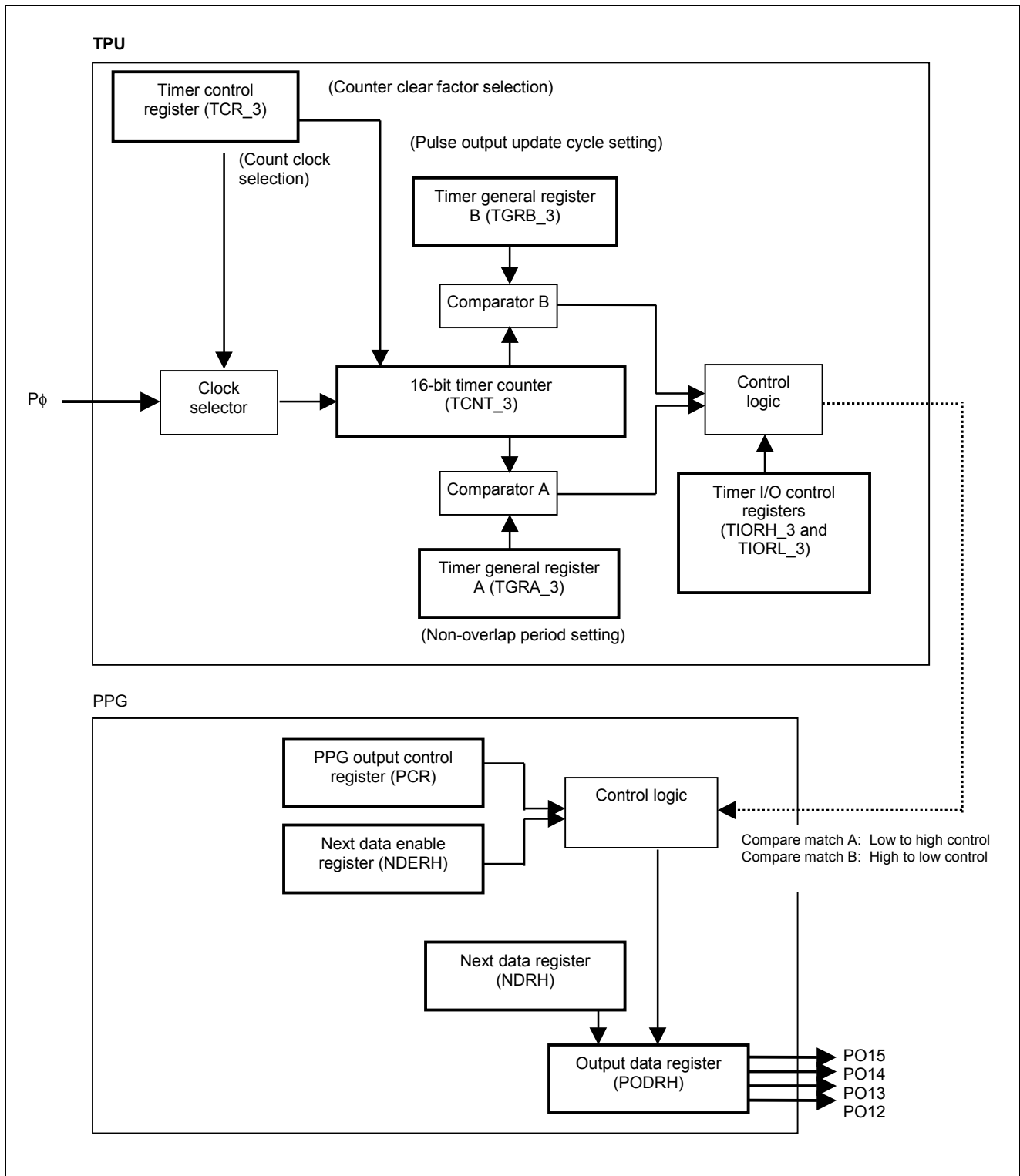


Figure 1 Block Diagram of Four-Phase Pulse Output Using the PPG

Figure 2 shows an example of non-overlap four-phase pulse output.

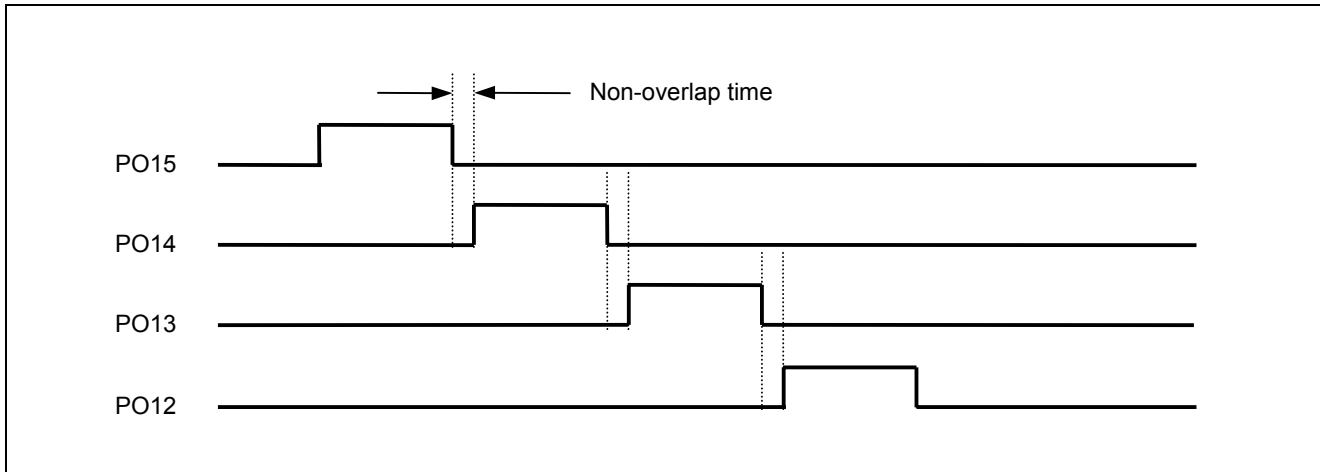


Figure 2 Example of Non-Overlap Four-Phase Pulse Output

3. Sample Program

3.1 Function

The timer count value for each of the pulse output trigger cycle (pulse output update cycle) and non-overlap period is set in each of timer general registers B and A respectively. You can calculate the timer values for the two times by using the following equations:

$$\begin{aligned} \text{trigger-cycle} &= \text{timer-value-set-in-TGRB_3} \times \text{TPU3-count-clock} \\ \text{non-overlap-period} &= \text{timer-value-set-in-TGRA_3} \times \text{TPU3-count-clock} \end{aligned}$$

Assume that the TPU3 count clock is peripheral module (P ϕ)/1. When P ϕ is 25 MHz, the TPU3 count clock is 40 nsec. The non-overlap period must be shorter than the trigger cycle (TGRA_3 < TGRB_3). Figure 3 shows an example of operation.

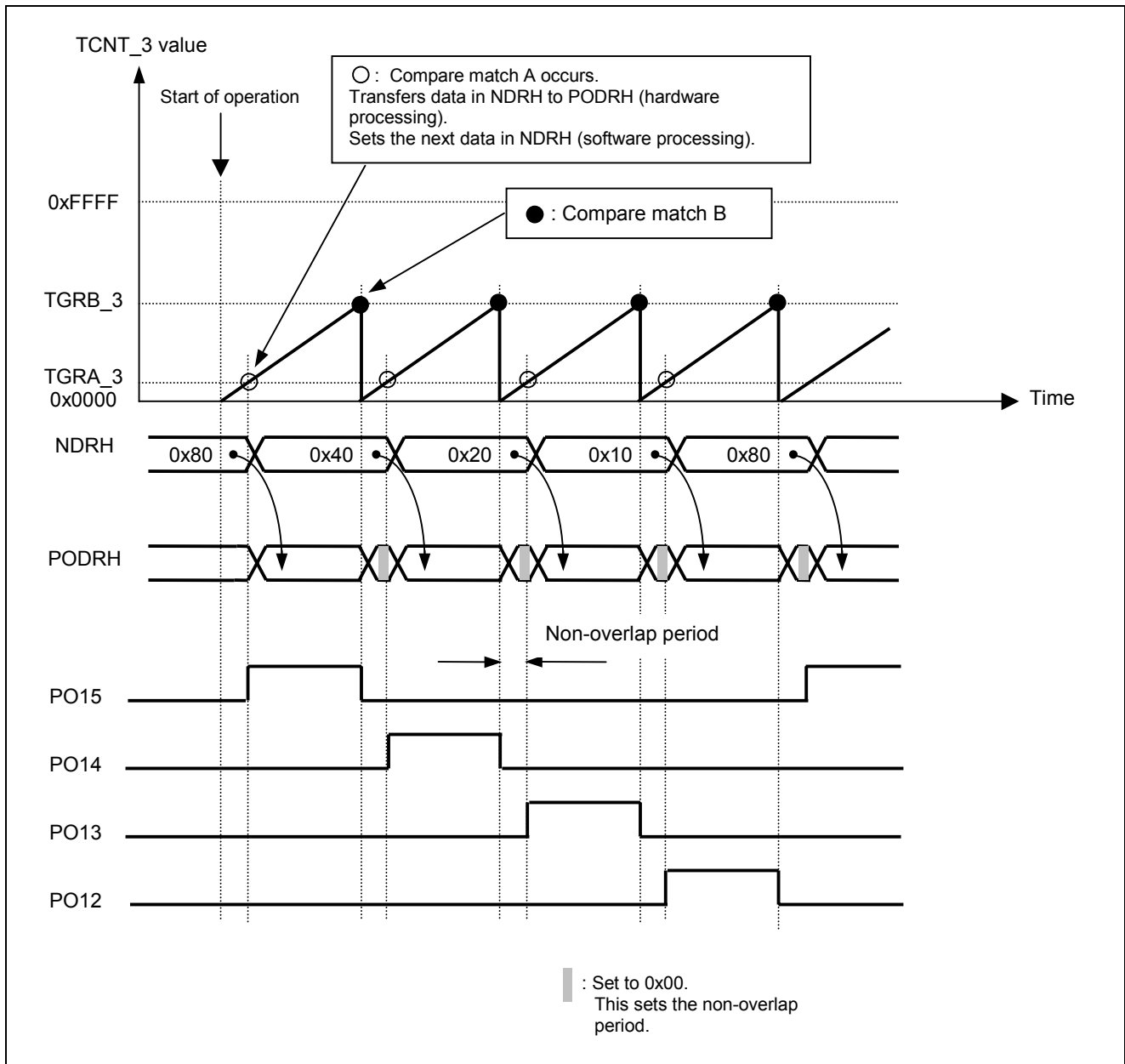


Figure 3 Example of Non-Overlap Four-Phase Pulse Output Operation

Table 1 lists the function allocations used TPU3 and PPG.

Table 1 Function Allocation in TPU3 and PPG

Type	Name	Function	
Common	Register	MSTPCRA	Cancels the TPU and PPG module stop mode.
		TSTR	Specifies whether to start or stop the TPU3 timer count operation.
TPU3	Register	TCR_3	Sets the TCNT_3 count clock and counter clear factor.
		TGRA_3	Compare match counter value for the non-overlap period
		TGRB_3	Compare match counter value for the pulse output trigger period
		TIORH_3	Sets the no output when a compare match occurs.
		TIER_3	Enables interrupts by compare match A.
PPG	Register	PMR	Sets non-overlap mode.
		PCR	Sets the pulse output trigger.
		NDERH	Enables PO15 to PO12 pulse output.
		NDRH	Stores the next output data of PO15 to PO12.
		PODRH	Stores output data of PO15 to PO12.
	Output pin	PO15 to PO12	Pulse output pin

3.2 Function Specifications

The functions that set pulse output are shown as a sample program. The function specifications are listed below.

(1) Routine for setting four-pulse output using the PPG

```
void ppg4_set ( unsigned short non_overlap_count, unsigned short
trigger_count )
```

Argument	Description
non_overlap_count	Specifies the timer value for the non-overlap period. If non_overlap_count is greater than or equal to trigger_count, normal operation is not performed. The count clock is fixed to P ϕ /1.
trigger_count	Specifies the timer value for the pulse output trigger cycle. If trigger_count is smaller than or equal to non_overlap_count, normal operation is not performed. The count clock is fixed to P ϕ /1.

Return value	Description
None	—

(2) Compare match A interrupt handler

```
void inthdr_compareA ( void )
```

This function has neither an argument nor return value because it is a TPU3 interrupt handler. You must register this interrupt handler in the interrupt vector table.

Example)

```
#define TRIGGER_TIME      2000      // Delay: 2000 µsec
#define NON_OVERLAP_TIME  100      // High width: 100 µsec
#define P_CLOCK           25       // PΦ (MHz)
                                   // External function reference declaration
extern void ppg4_set ( unsigned short, unsigned short );
void main( void )                // Main routine
{
    unsigned short  trigger;
    unsigned short  nonoverlap;

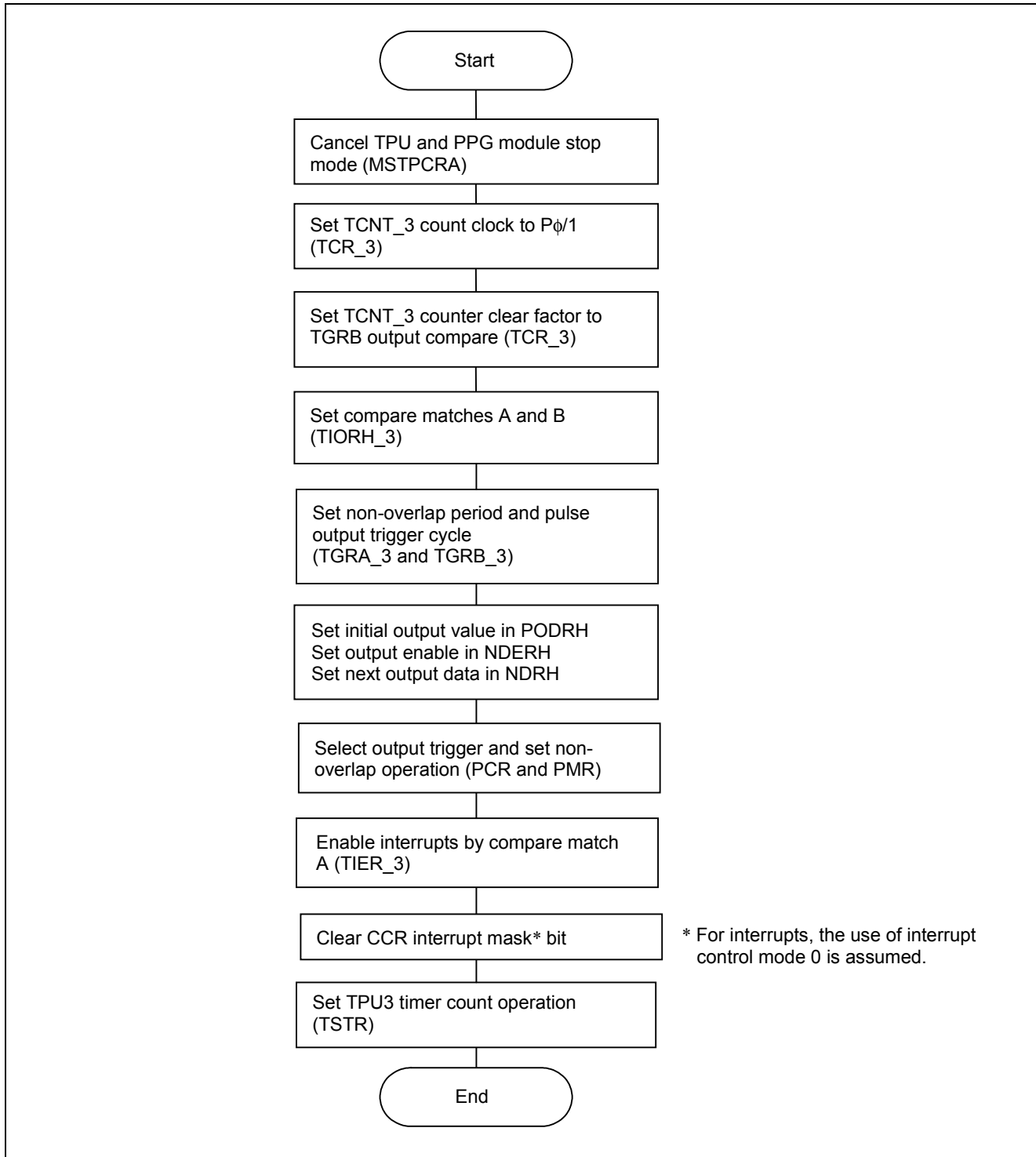
    trigger         = ((unsigned short)TRIGGER_TIME      *P_CLOCK);
    nonoverlap      = ((unsigned short)NON_OVERLAP_TIME *P_CLOCK);
                                   // Sets non-overlap pulse output.
    ppg4_set ( nonoverlap, trigger );

    ...
}
```

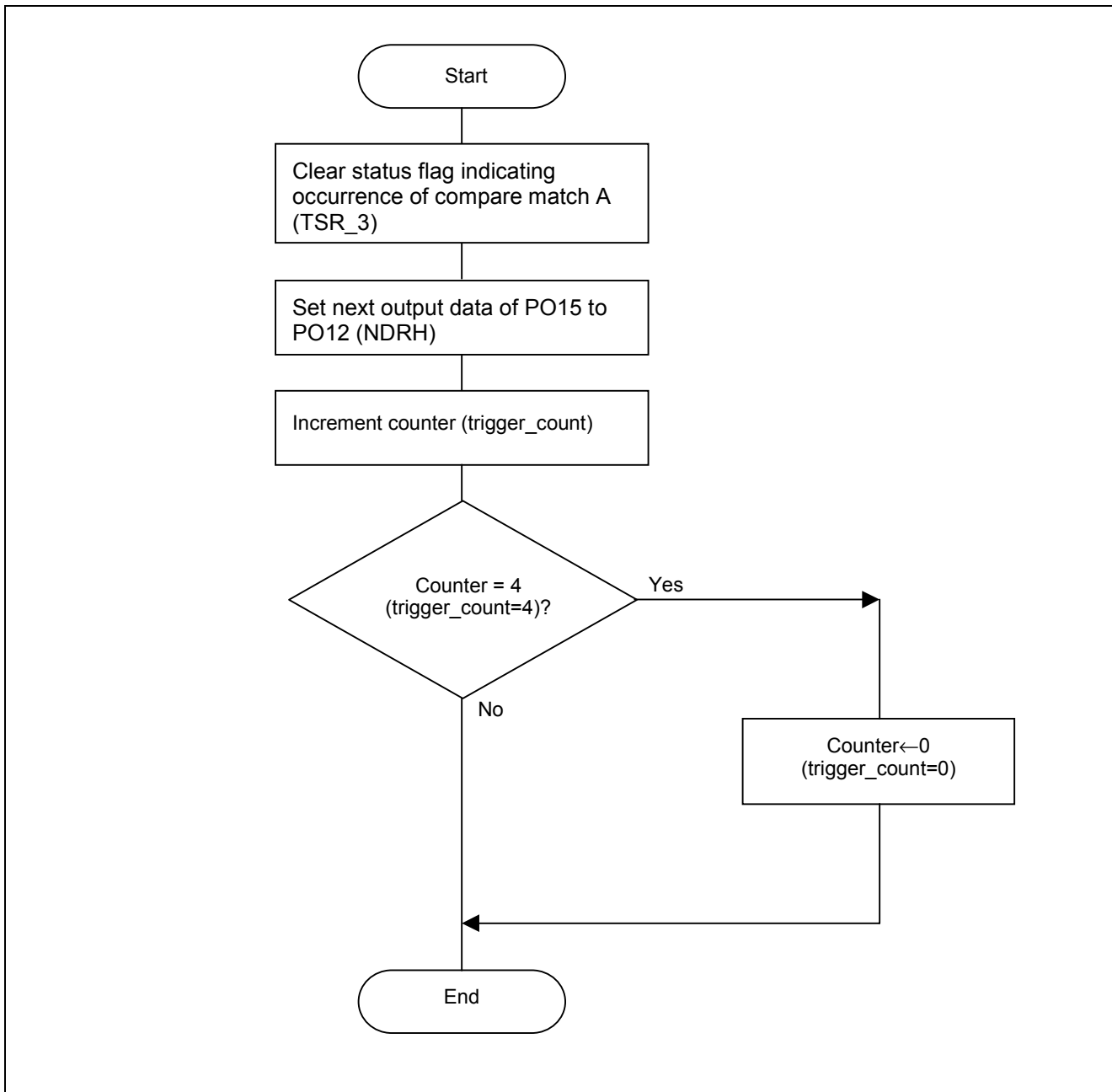
3.3 Flowchart

The processing flow is shown below.

(1) void ppg4_set (unsigned short, unsigned short)



(2) void inthdr_compareA (void)



3.4 Program Listing

A source program listing is shown below. In this source program, Renesas's standard definition (file automatically generated by High-performance Embedded Workshop: iodefine.h) defines the I/O register structure. If you want to specify your own definition, change the I/O register structure in the sample program.

```

/*****
/* include file
/*****
#include <machine.h>
#include "iodefine.h"

/*****
/* function prototype
/*****
void ppg4_set( unsigned short, unsigned short );

/*****
/* static variable
/*****
static const unsigned char next_data[4]
                = { 0x80, 0x40, 0x20, 0x10 };
static unsigned char trigger_count;

/*****
/* function definition
/*****
void ppg4_set( unsigned short non_overlap_count,
                unsigned short trigger_count )
{
    P_MSTPCRA.BIT.MSTPA0 = 0;    // reset module-standby for TPU
    P_MSTPCRB.BIT.MSTPB15 = 0;   // reset module-standby for PPG
    P_TPU3.TCR.BIT.TPSC = 0;    // set TPU3 countup clock source
    P_TPU3.TCR.BIT.CCLR = 2;    // set TPU3 counter clear cause
    P_TPU3.TIOR.BIT.IOA = 0;    // set TPU3 compare-match-A
    P_TPU3.TIOR.BIT.IOB = 0;    // set TPU3 compare-match-B
    P_TPU3.TGRA = (unsigned int)non_overlap_count;
    P_TPU3.TGRB = (unsigned int)trigger_count;
    P_PPG.PODR.BIT.POD15 = 0;    // set PPG initial pulse data
    P_PPG.PODR.BIT.POD14 = 0;
    P_PPG.PODR.BIT.POD13 = 0;
    P_PPG.PODR.BIT.POD12 = 0;
    trigger_count = 0;          // set PPG next pulse data
    P_PPG.NDRH1.BYTE = next_data[trigger_count++];
    P_PPG.NDER.BIT.NDER15 = 1;   // set PPG next pulse enable
    P_PPG.NDER.BIT.NDER14 = 1;
    P_PPG.NDER.BIT.NDER13 = 1;
    P_PPG.NDER.BIT.NDER12 = 1;
    P_PPG.PMR.BIT.G3NOV = 1;     // set PPG non-overlap mode
    P_PPG.PCR.BIT.G3CMS = 3;     // set PPG output trigger
    P_TPU3.TIER.BIT.TGIEA = 1;  // set TGI3A-interrupt enable
    set_imask_ccr(0);           // clear interrupt mask
    P_TPU.TSTR.BIT.CST3 = 1;    // start TPU3

```

```
}

/*****
/* interrupt handler definition */
/*****
#pragma interrupt ( inthdr_compareA )
void inthdr_compareA( void )
{
    volatile unsigned char dummy;
    dummy = P_TPU3.TSR.BYTE;    // read TPU3 interrupt status
    P_TPU3.TSR.BIT.TGFA = 0;   // clear TGI3A-interrupt status
                                // set PPG next pulse data
    P_PPG.NDRH1.BYTE = next_data[trigger_count++];
    if ( 4 <= trigger_count )   trigger_count = 0;
}
}
```

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sept.19.03	—	First edition issued

Keep safety first in your circuit designs!

1. Renesas Technology Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corporation product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corporation or a third party.
2. Renesas Technology Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors. Renesas Technology Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corporation by various means, including the Renesas Technology Corporation Semiconductor home page (<http://www.renesas.com>).
4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
5. Renesas Technology Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
6. The prior written approval of Renesas Technology Corporation is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corporation for further details on these materials or the products contained therein.